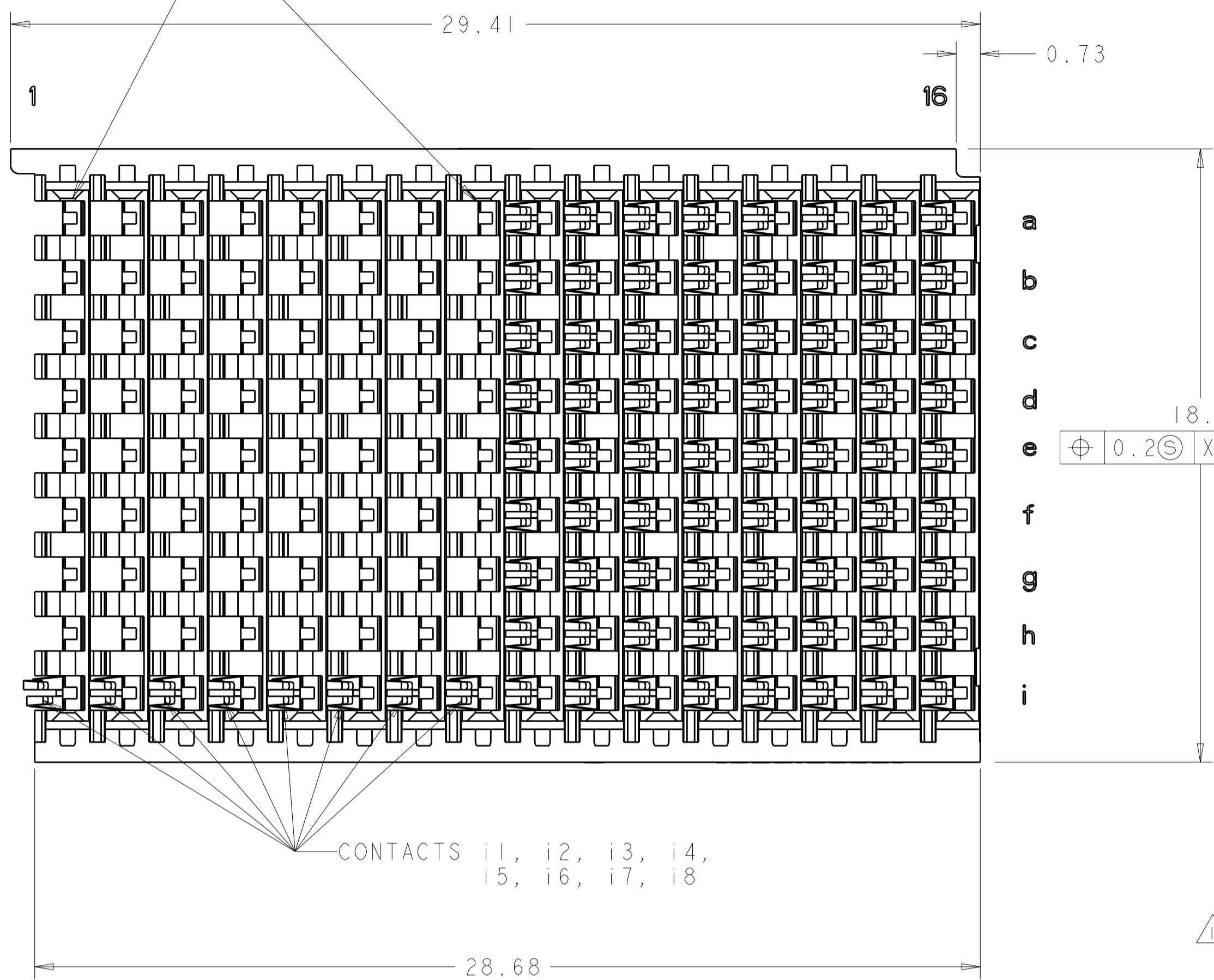
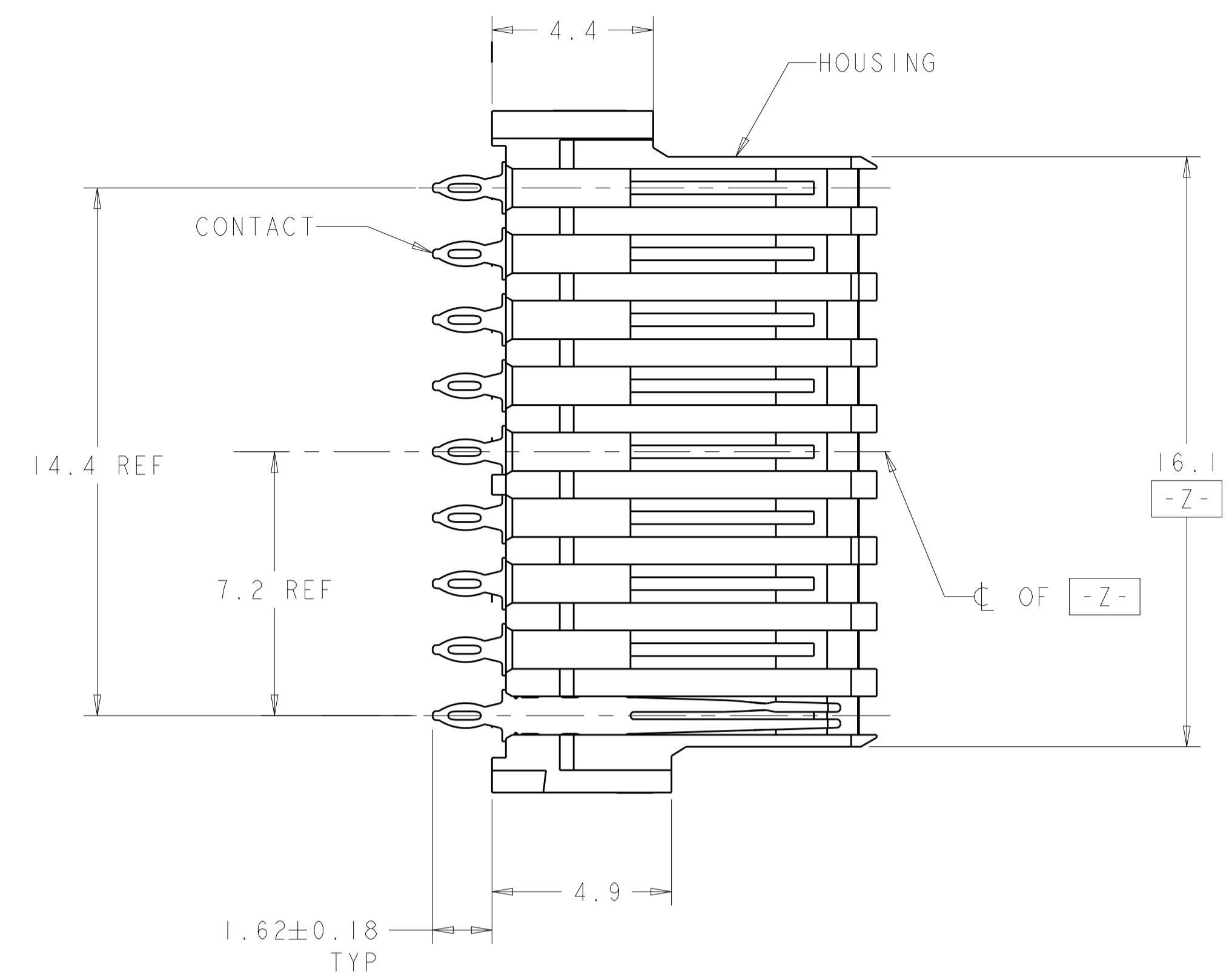
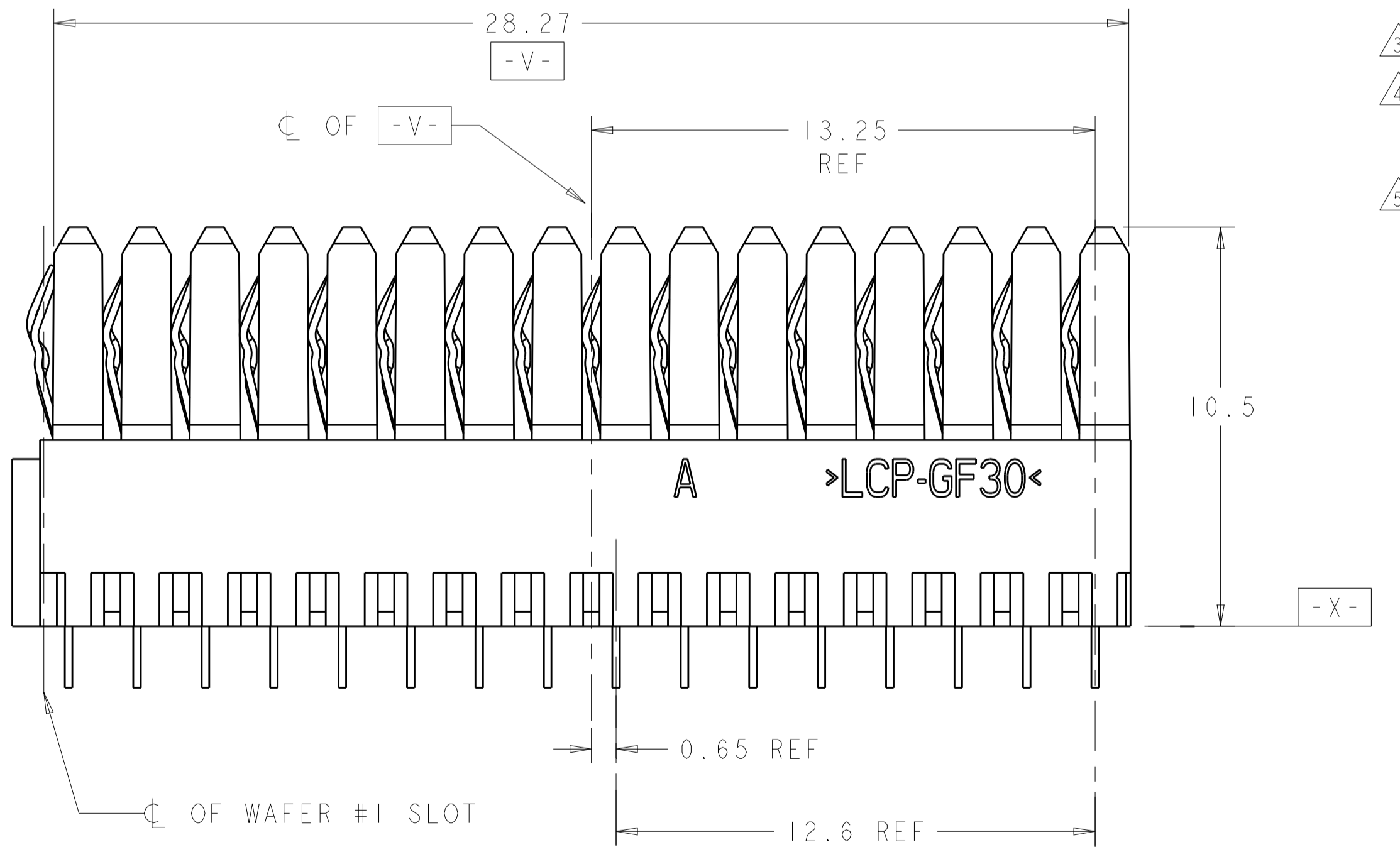
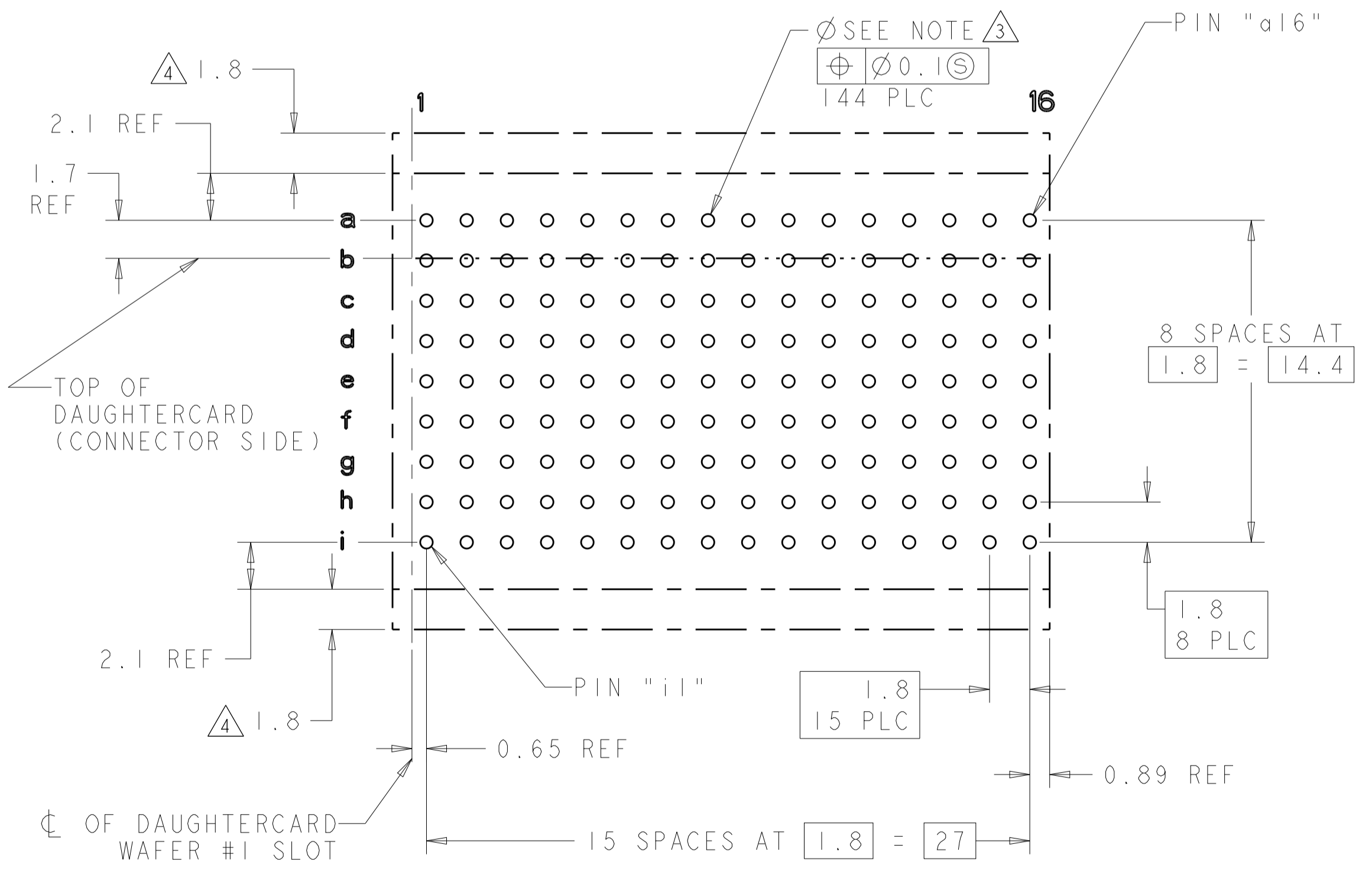


LOC		DIST		REVISIONS			
P	LTN	DESCRIPTION	DATE	DWN	APVD		
B		RELEASED PER ECO-13-004502	12MAR2013	KM	DH		
C		REVISED PER ECO-13-008265	20MAY2013	DB	DH		

COLUMN 1 THRU 8
CONTACTS NOT LOADED
EXCEPT i1, i2, i3, i4, i5, i6, i7, i8



- △ HOUSING: LCP, UL94V0, COLOR: BLACK.
CONTACT: PHOSPHOR BRONZE.
- △ FINISH: 1.27µm GOLD IN CONTACT AREA 1.27µm MIN. TIN-LEAD ON PCB TAIL OVER 2.54µm MIN. NICKEL OVER ALL.
- △ PLATED THROUGH HOLE PER 114-13056, FIGURE 4
- △ ADDITIONAL CONNECTOR-SIDE KEEPOUT AREA REQUIRED IF CONNECTOR-SIDE EXTRACTION TOOL IS TO BE USED.
- △ FINISH: 1.27µm MIN GOLD IN CONTACT AREA, 0.50µm MIN TIN ON PCB TAIL OVER 2.54µm MIN. NICKEL OVER ALL.



△	2102851-2
△	2102851-1
PLATING	PART NO

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS:	TOLERANCES UNLESS OTHERWISE SPECIFIED:	DWN: K. MILLER 29NOV2011	CHK: K. THACKSTON 12JAN2012	APVD: M. McALONIS 12SEP2012	NAME: CONNECTOR ASSEMBLY, BACKPLANE VERTICAL RECEPTACLE, CENTER, 20.3mm, MULTIGIG RT 2-R
mm	0 PLC ±0.5 1 PLC ±0.5 2 PLC ±0.13 3 PLC ±0.13 4 PLC ±0.13 ANGLES ±1°	PRODUCT SPEC: 108-2072	APPLICATION SPEC: 114-13056	WEIGHT: 5.35g	SIZE: A1
MATERIAL: △	SEE TABLE	RESTRICTED TO: -	Customer Drawing	SCALE: 8:1	SHEET 1 OF 1 REV C

STE TE Connectivity